

C0603X123M3TACAUTO

SMD Auto X8G HT150C Flex, Ceramic, 0.012 uF, 20%, 25 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade, 0603, 0.4 mm





| SMD Auto X8G HT150C Flex |
|--|
| SMD Chip |
| SMD, MLCC, High Temperature, Ultra-Stable, Automotive Grade |
| High Temperature, Ultra-Stable, Automotive Grade |
| Yes |
| Flexible Termination |
| No |
| AEC-Q200 |
| Yes |
| 4.6 mg |
| 78 Weeks |
| 1 |
| |

| Dimensions | |
|------------|------------------|
| Chip Size | 0603 |
| L | 1.6mm +/-0.17mm |
| W | 0.8mm +/-0.15mm |
| Т | 0.8mm +/-0.15mm |
| S | 0.4mm MIN |
| В | 0.45mm +/-0.15mm |

| Packaging Specifications | |
|--------------------------|------------------------|
| Packaging | T&R, 180mm, Paper Tape |
| Packaging Quantity | 4000 |

| Specifications | |
|--|--|
| Capacitance | 0.012 uF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 20% |
| Voltage DC | 25 VDC |
| Dielectric Withstanding Voltage | 62.5 VDC |
| Temperature Range | -55/+150°C |
| Temp. Coefficient | X8G |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1kHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 kHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour: Referee Time is 1000 Hours |
| Insulation Resistance | 83.3333 GOhms |

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